## **ALUMINUM ELECTROLYTIC CAPACITORS**

**UZR** 

3.95mmL MAX. Chip Type







- Chip type with 3.95mmLMAX height.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- Compliant to the RoHS directive (2011/65/EU).

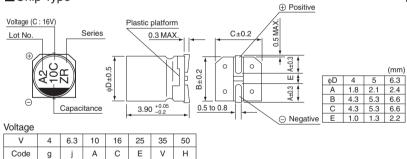




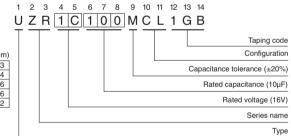
### ■Specifications

Item	Performance Characteristics									
Category Temperature Range	-40 to +85°C									
Rated Voltage Range	4 to 50V									
Rated Capacitance Range	0.1 to 220μF									
Capacitance Tolerance	±20% at 120Hz, 20°C									
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.01 CV or 3 (µA), whichever is greater.									
Tangent of loss angle (tan δ)	Rated voltage (V)		4	6.3	10	16	25	35	50	120Hz 20°C
	tan δ (MAX.)		0.50	0.30	0.24	0.19	0.16	0.14	0.14	
	Rated voltage (V)		4	6.3	10	16	25	35	50	120Hz
Stability at Low	Impedance ratio ZT / Z20 (MAX.)	Z-25°C / Z+20°C	7	4	3	2	2	2	2	
Temperature		Z-40°C / Z+20°C	15	8	8	4	4	3	3	
Endurance	The specifications listed at right shall be met when the capacitors are restored to $20^{\circ}$ C after the rated voltage is applied for 1000 hours at $85^{\circ}$ C.  Capacitance change Within $\pm 30\%$ of the initial capacitance value $\tan \delta$ 300% or less than the initial specified value Leakage current Less than or equal to the initial specified value								al specified value	
Shelf Life	After storing the capacitors under no load at 85°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.									
Resistance to soldering heat	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C. The capacitors shall meet the characteristic requirements listed at right when they are removed from the plate and restored to 20°C.  Capacitance change   Within ±10% of the initial capacitant of the initial specification of the initial capacitant of the initi						to the initial specified value			
Marking	Black print on the case top.									

### ■Chip Type



Type numbering system (Example: 16V 10µF)



# Code g j Dimensions

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	V		4		.3		0		6		25		5		0
Cap. (μF)	Code	0	G	C	J	1	A	1	С	1	E	1	V	1	H
0.1	0R1										!		!	4	1.0
0.22	R22		i		i		i		İ		İ		i	4	2.0
0.33	R33		I I		l I		l I		-		1		I I	4	2.8
0.47	R47		I I		l I								! !	4	4.0
1	010		i		i		i						i	4	8.4
2.2	2R2		I I		I I		I I		i i		i i		I I	4	13
3.3	3R3										!			4	17
4.7	4R7		İ		l I		1			4	16	4	18	5	20
10	100		I I		I I		I I	4	23	5	27	5	29	6.3	33
22	220		İ	4	28	5	33	5	37	6.3	42	6.3	46		[
33	330	4	28	5	37	5	41	6.3	49	6.3	52		İ		Í
47	470	4	33	5	45	6.3	52	6.3	58		İ		I I		I
100	101	5	56	6.3	70		!				!		!		[
220	221	6.3	96											Case size	Rated

Rated ripple current (mArms) at 85°C 120Hz

#### • Frequency coefficient of rated ripple current

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	Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
	Coefficient	0.70	1.00	1.17	1.36	1.50

- Taping specifications are given in page 23.
- Recommended land size soldering by reflow are given in page 18,19.
- Please refer to page 3 for the minimum order quantity.